

SOT-26



Pin Definition:

- | | |
|-------------|-------------|
| 1. Gate 1 | 6. Drain 1 |
| 2. Source 2 | 5. Source 1 |
| 3. Gate 2 | 4. Drain 2 |

Key Parameter Performance

| Parameter | | Value | Unit |
|--------------------|------------------|-------|------|
| V_{DS} | | -20 | V |
| $R_{DS(on)}$ (max) | $V_{GS} = -4.5V$ | 140 | mΩ |
| | $V_{GS} = -2.5V$ | 200 | |
| | $V_{GS} = -1.8V$ | 300 | |
| Q_g | | 15.23 | nC |

Features

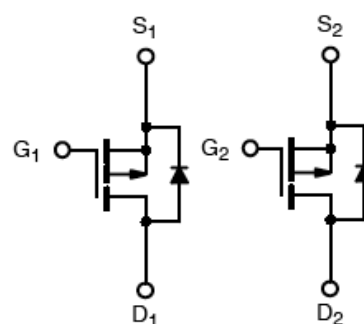
- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

Ordering Information

| Part No. | Package | Packing |
|-----------------|---------|-----------------|
| TSM3911DCX6 RF | SOT-26 | 3kpcs / 7" Reel |
| TSM3911DCX6 RFG | SOT-26 | 3kpcs / 7" Reel |

Note: "G" denotes for Halogen- and Antimony-free as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

Block Diagram



Dual P-Channel MOSFET

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|----------------|--------------------------------|------------------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Gate-Source Voltage | V_{GS} | ± 8 | V |
| Continuous Drain Current | I_D | -2.2 | A |
| Pulsed Drain Current | I_{DM} | -8 | A |
| Continuous Source Current (Diode Conduction) ^(Note 1,2) | I_S | -0.72 | A |
| Maximum Power Dissipation | P_D | $T_A=25^\circ\text{C}$ 1.15 | W |
| | | $T_A=70^\circ\text{C}$ 0.73 | |
| Operating Junction Temperature | T_J | +150 | $^\circ\text{C}$ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | - 55 to +150 | $^\circ\text{C}$ |

Thermal Performance

| Parameter | Symbol | Limit | Unit |
|--|-------------------|-------|--------------------|
| Junction to Case Thermal Resistance | $R_{\theta_{JF}}$ | 30 | $^\circ\text{C/W}$ |
| Junction to Ambient Thermal Resistance (PCB mounted) | $R_{\theta_{JA}}$ | 80 | $^\circ\text{C/W}$ |

Electrical Specifications

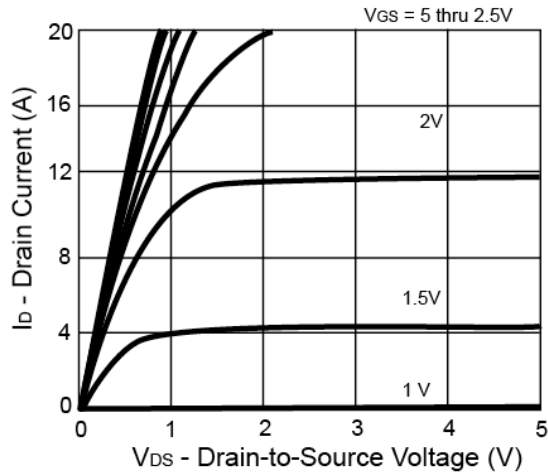
| Parameter | Conditions | Symbol | Min | Typ | Max | Unit |
|----------------------------------|---|---------------------|-------|--------|-------|------|
| Static (Note 3) | | | | | | |
| Drain-Source Breakdown Voltage | V _{GS} = 0V, I _D = -250μA | BV _{DSS} | -20 | -- | -- | V |
| Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = -250μA | V _{GS(TH)} | -0.45 | -- | -0.95 | V |
| Gate Body Leakage | V _{GS} = ±8V, V _{DS} = 0V | I _{GSS} | -- | -- | ±100 | nA |
| Zero Gate Voltage Drain Current | V _{DS} = -16V, V _{GS} = 0V | I _{DSS} | -- | -- | -1.0 | μA |
| On-State Drain Current | V _{DS} = -5V, V _{GS} = -5V | I _{D(ON)} | -5 | -- | -- | A |
| Drain-Source On-State Resistance | V _{GS} = -4.5V, I _D = -2.2A | R _{DS(ON)} | -- | 115 | 140 | mΩ |
| | V _{GS} = -2.5V, I _D = -1.8A | | -- | 163 | 200 | |
| | V _{GS} = -1.8V, I _D = -1A | | -- | 220 | 300 | |
| Forward Transconductance | V _{DS} = -5V, I _D = -2.2A | g _{fs} | -- | 5 | -- | S |
| Diode Forward Voltage | I _S = -1.05A, V _{GS} = 0V | V _{SD} | -- | - 0.8 | -1.2 | V |
| Dynamic (Note 4) | | | | | | |
| Total Gate Charge | V _{DS} = -6V, I _D = -2.8A, V _{GS} = -4.5V | Q _g | -- | 15.23 | -- | nC |
| Gate-Source Charge | | Q _{gs} | -- | 5.49 | -- | |
| Gate-Drain Charge | | Q _{gd} | -- | 2.74 | -- | |
| Input Capacitance | V _{DS} = -6V, V _{GS} = 0V, f = 1.0MHz | C _{iss} | -- | 882.51 | -- | pF |
| Output Capacitance | | C _{oss} | -- | 145.54 | -- | |
| Reverse Transfer Capacitance | | C _{rss} | -- | 97.26 | -- | |
| Switching (Note 4,5) | | | | | | |
| Turn-On Delay Time | V _{DD} = -6V, R _L = 6Ω, I _D = -1A, V _{GEN} = -4.5V, R _G = 6Ω | t _{d(on)} | -- | 17.28 | -- | ns |
| Turn-On Rise Time | | t _r | -- | 3.73 | -- | |
| Turn-Off Delay Time | | t _{d(off)} | -- | 36.05 | -- | |
| Turn-Off Fall Time | | t _f | -- | 6.19 | -- | |

Notes:

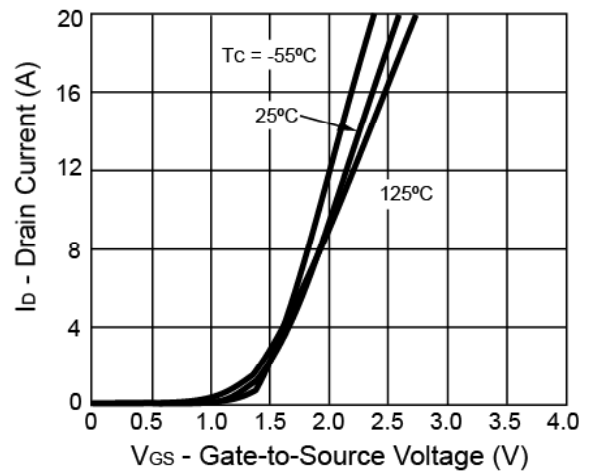
1. Pulse width limited by the Maximum junction temperature
2. Surface Mounted on FR4 Board, $t \leq 5$ sec.
3. pulse test: $PW \leq 300\mu s$, duty cycle $\leq 2\%$
4. For DESIGN AID ONLY, not subject to production testing.
5. Switching time is essentially independent of operating temperature.

Electrical Characteristics Curves

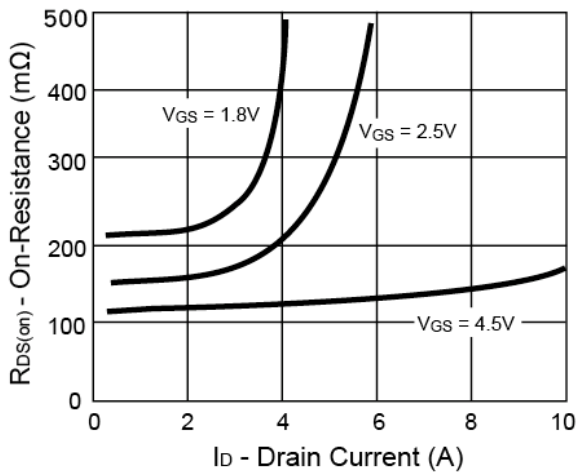
Output Characteristics



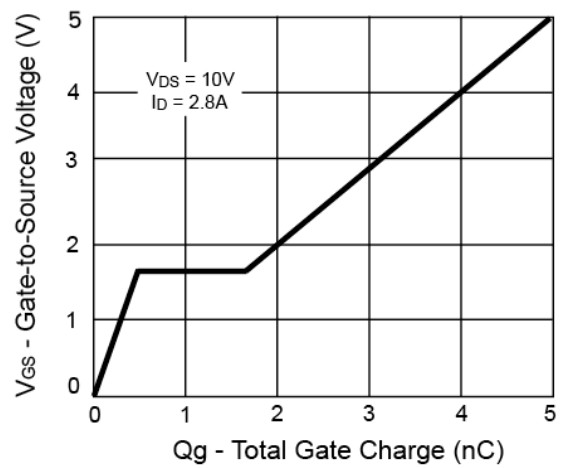
Transfer Characteristics



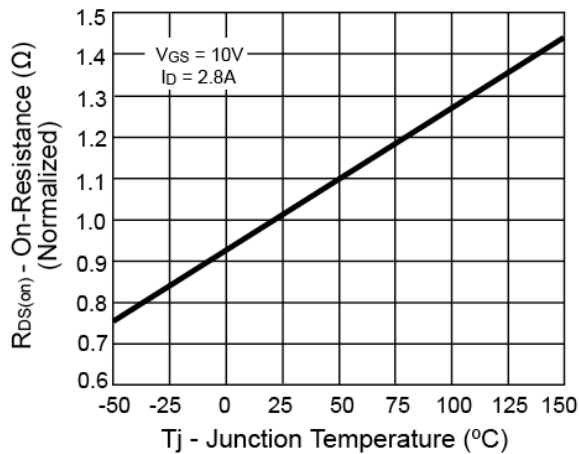
On-Resistance vs. Drain Current



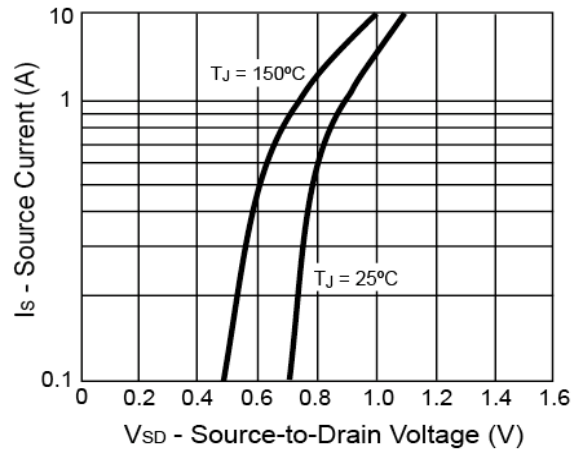
Gate Charge



On-Resistance vs. Junction Temperature

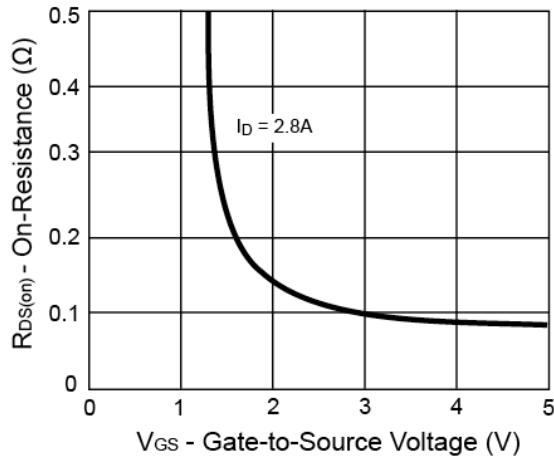


Source-Drain Diode Forward Voltage

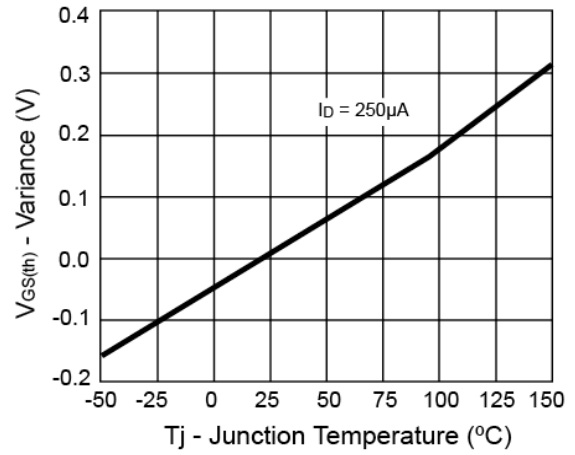


Electrical Characteristics Curves

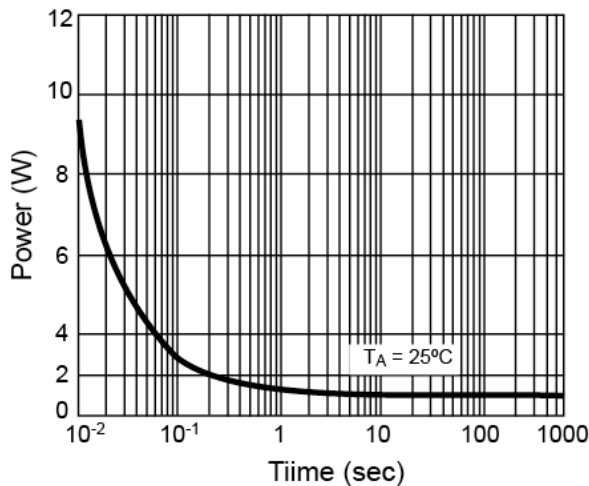
On-Resistance vs. Gate-Source Voltage



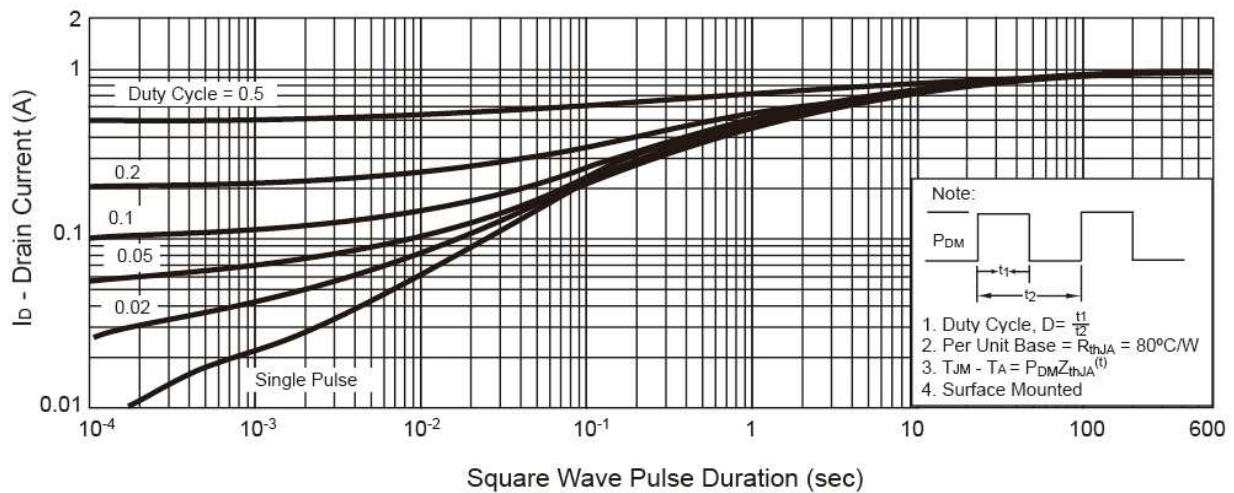
Threshold Voltage



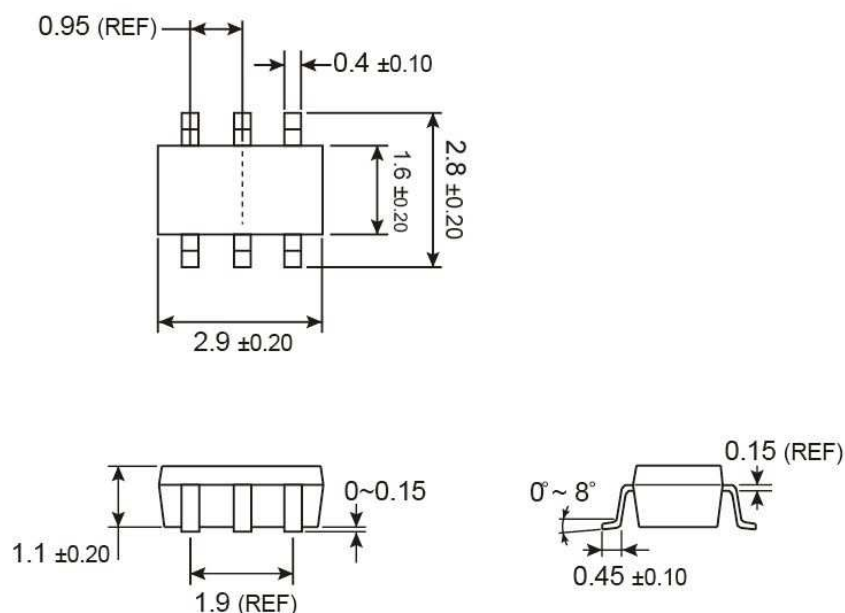
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

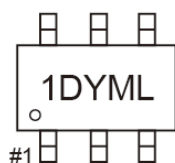


SOT-26 Mechanical Drawing



Unit: Millimeters

Marking Diagram



1D = Device Code

Y = Year Code

M = Month Code

(**A**=Jan, **B**=Feb, **C**=Mar, **D**=Apr, **E**=May, **F**=Jun, **G**=Jul, **H**=Aug, **I**=Sep, **J**=Oct, **K**=Nov, **L**=Dec)

= Month Code for Halogen Free Product

(**O**=Jan, **P**=Feb, **Q**=Mar, **R**=Apr, **S**=May, **T**=Jun, **U**=Jul, **V**=Aug, **W**=Sep, **X**=Oct, **Y**=Nov, **Z**=Dec)

L = Lot Code

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.